

No clean leaded flux cored solder wire

JM-20



- Fast soldering with remarkable wetting speed drastically increases production yields
- Very low spitting of flux, very low fume levels
- Clear flux residue offers superior cosmetics

Product specifications

Product name	JS-20
Alloy composition (%)	Sn 40Pb
Flux content (%)	2.2
Halide content (%)	0.0
Flux type	ROLO
Sliver chromate paper test	No discoloration
Solder spread factor (%)	90
Solder wetting speed* (sec.)	< 0.5
Flux residue stickiness (by chalk powder)	No attachment
Diameter (mm)	0.3, 0.4, 0.5, 0.6, 0.8, 1.0, 1.2, 1.6

* Solder wetting speed: By meniscograph with copper plate (30x7x0.2mm) at 230°C